



DECLARATION FOR PATENT APPLICATION

1581/00097

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: Functional Groups-Terminated Vinyl Polymers the specification of which: (check one)

[] is attached hereto.

[x] was filed on July 28, 1998 as U.S. Patent Application S.N. 09/122,896, and was amended on July 28, 1998.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with 37 CFR § 1.56(a).

Prior Foreign Application(s): I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate listed below, or § 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

н	ei-9-218089	Innon	99 X 1 100=	Priority Claimed				
		Japan	28 July 1997	_ [x] [
(Application No.)		(Country)	(Day/Month/Year Filed)	Yes No				
Hei-9-218090		Japan	28 July 1997	[x] [
(Application No.)		(Country)	(Day/Month/Year Filed)	Yes No				
Hei-9-218091		Japan	28 July 1997	[x] [
	(Application No.)	(Country)	(Day/Month/Year Filed)	Yes No				
I hereby claim the benefit under Title 35, United States Code § 119(e) of any United States provisional application(s) listed below. Application No. Filing Date								
1,3	Appheauon 14	0.	Filing Date					
2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2								
I hereby claim the benefit under 35 U.S.C § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by 35 U.S.C. § 112, first paragraph, I acknowledge the duty to disclose material information as defined in 37 CFR § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:								
T STATE OF THE STA	(U.S. Application Serial No.)	(U.S. Filing Date)	(Statuspatented, pending, a	abandoned)				
	(U.S. Application Serial No.)	(U.S. Filing Date)	(Statuspatented, pending, a	abandoned)				
3 Stantey	y appoint Elliott I Pollock, Registration No. I B. Green, Registration No. 24,351; Richard ration No. 24,510; Martin Abramson, Registrati	Wiener, Registration No. 18,741: To	wnsend M. Belser, Ir. Registration No. 2	2 056: Marrie Lice				

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business in the Patent and Trademark Office connected therewith.

Burton A. Amernick
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements are made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

and Eric J. Franklin, Registration No 37,134, my attorneys with full power of substitution and revocation, to prosecute this application and to transact all

Full name of sole or first inventor: Yoshiki Nakagawa	,,
Inventor's Signature Johns Pokengan	Date SEP. 2 1, 1998
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Page Two

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